



TI LaunchPad™ kit with SimpleLink™ Wireless MCU

Microcontroller development kit for rapid prototyping featuring
the CC1310 MCU and CC1190 range extender

PART NO: LAUNCHXL-CC13-90



LAUNCH
YOUR DESIGN

START @

dev.ti.com/LAUNCHXL-CC13-90

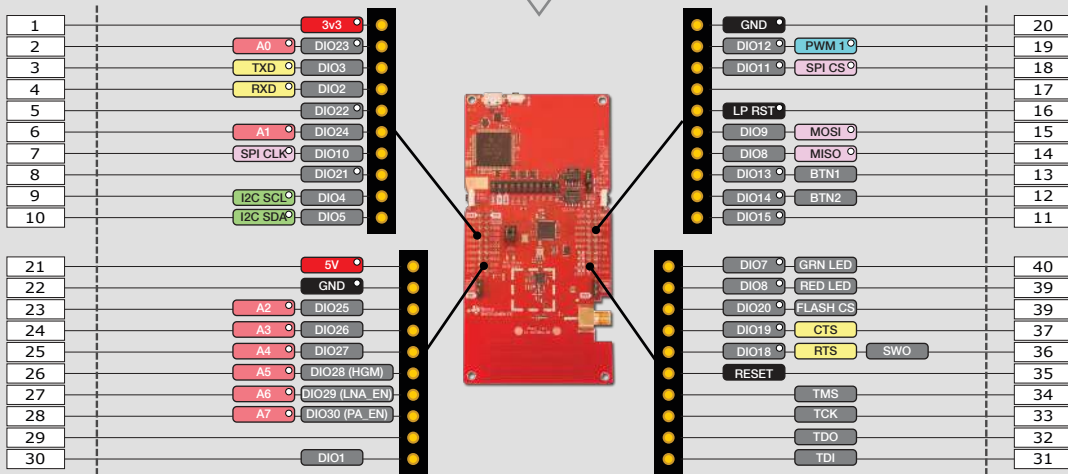


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○ Pin aligns with LaunchPad pinout standard.



Explore all TI LaunchPad™ kits @ www.ti.com/launchpad

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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